

FEATURES

- Low forward voltage drop.
- Excellent high temperature stability.
- Fast switching capability.
- Suffix "G" indicates Halogen-free part, ex.CP10S45SG.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228

MECHANICAL DATA

- Epoxy : UL94-V0 rated flame retardant.
- Case : Molded plastic, TO-277.
- Lead : Solder plated, solderable per MIL-STD-750, Method 2026.
- Polarity: Indicated by cathode band.
- Mounting Position : Any.

Description and Applications

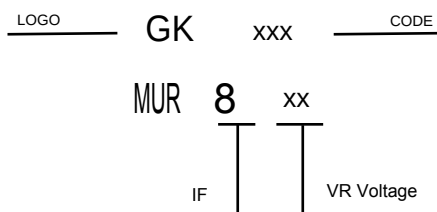
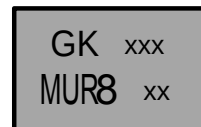
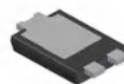
Suitable for rectification and freewheeling for SMPS, LED lighting, adapters, battery chargers, home appliances, office equipment, and telecommunication applications.

VOLTAGE RANGE

200 to 600 Volts

CURRENT

8.0 Ampere



LEFT PIN → RIGHT PIN → BOTTOMSIDE HEAT SINK

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature unless otherwise specified.
Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

TYPE NUMBER	MUR820	MUR840	MUR860	UNITS
Maximum Recurrent Peak Reverse Voltage	200	400	600	V
Maximum RMS Voltage	140	280	420	V
Maximum DC Blocking Voltage	200	400	600	V
Maximum Average Forward Rectified Current	8.0			A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	160			A
Maximum Instantaneous Forward Voltage at 8.0A	1.0	1.25	1.75	V
Maximum DC Reverse Current Ta=25°C	5.0			μA
at Rated DC Blocking Voltage Ta=100°C	150			μA
Maximum Reverse Recovery Time (Note 1)	35			nS
Typical Junction Capacitance (Note 2)	95			pF
Operating and Storage Temperature Range Tj, Tstg	-65 — +150			°C

NOTES:

1. Reverse Recovery Time test condition: IF=0.5A, IR=1.0A, IRR=0.25A
2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

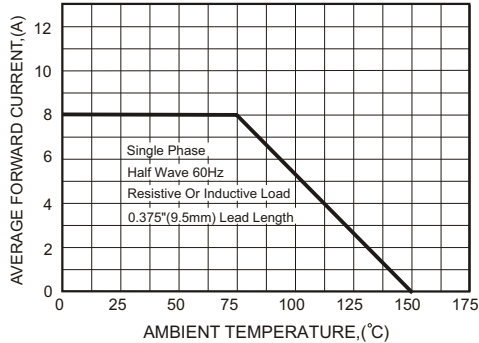


FIG.2-TYPICAL FORWARD CHARACTERISTICS

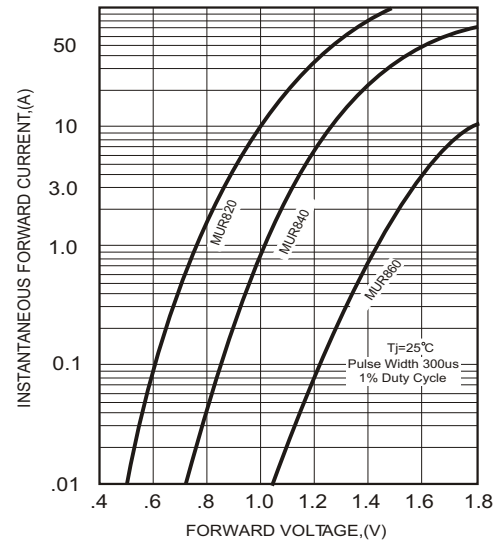
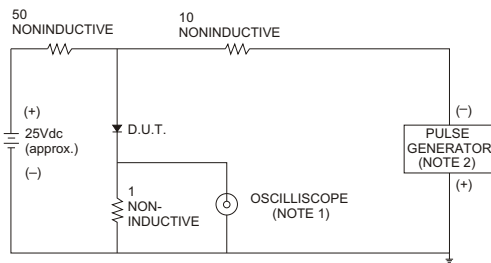


FIG.3- TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTICS



NOTES: 1. Rise Time= 7ns max., Input Impedance= 1 megohm.22pF.
2. Rise Time= 10ns max., Source Impedance= 50 ohms.

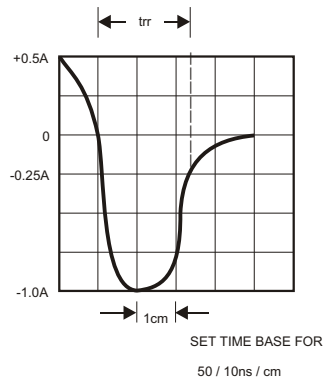


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

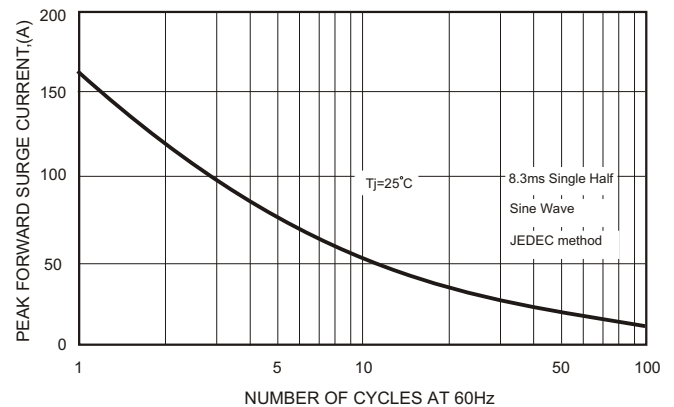


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

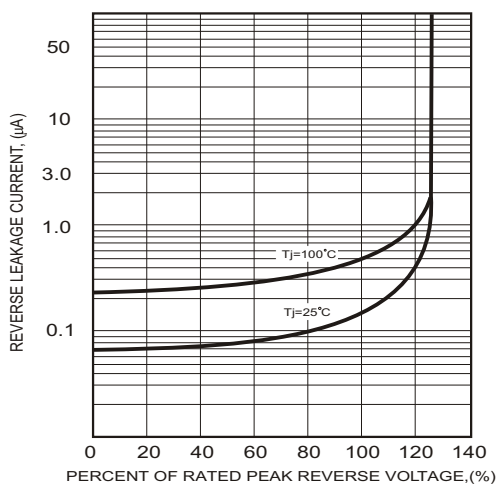
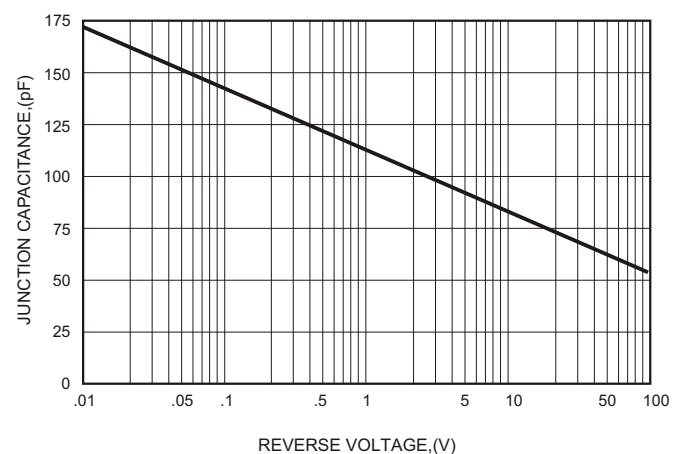
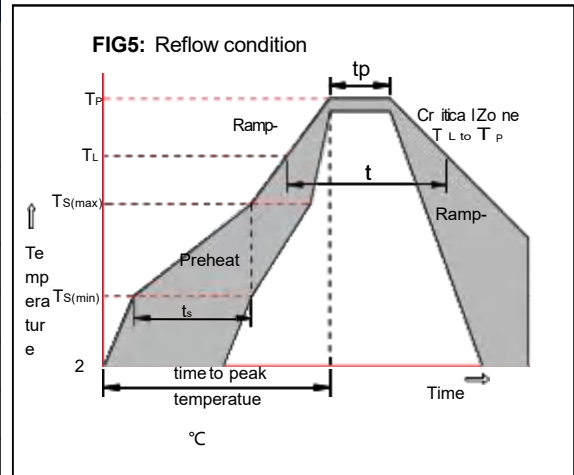


FIG.6-TYPICAL JUNCTION CAPACITANCE



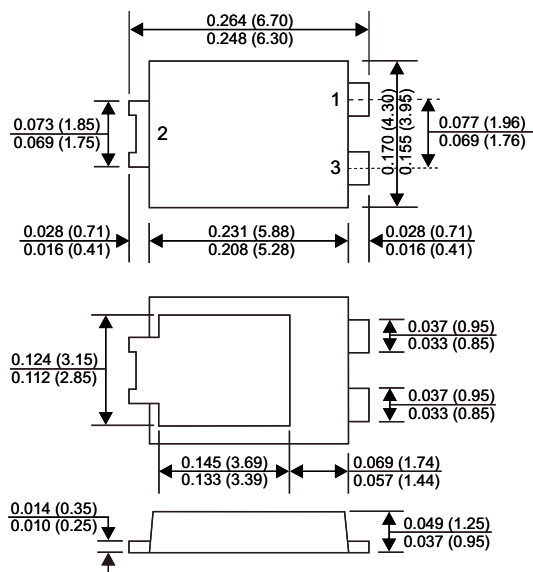
Soldering parameters

Reflow Condition		Pb-Free assembly (see as below)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150 °C
	-Temperature Max($T_{s(max)}$)	+200 °C
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3 °C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3 °C/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217 °C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5) °C
Time within 5 °C of actual Peak Temp (t_P)		30 secs. Max
Ramp-down Rate		6 °C/sec. Max
Time 25 °C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260 °C

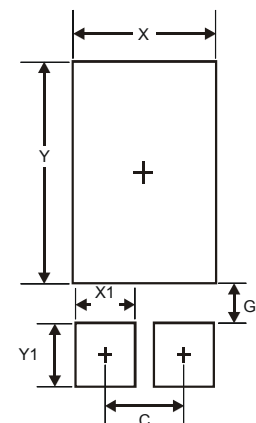


Package Dimensions & Suggested Pad Layout

TO - 277

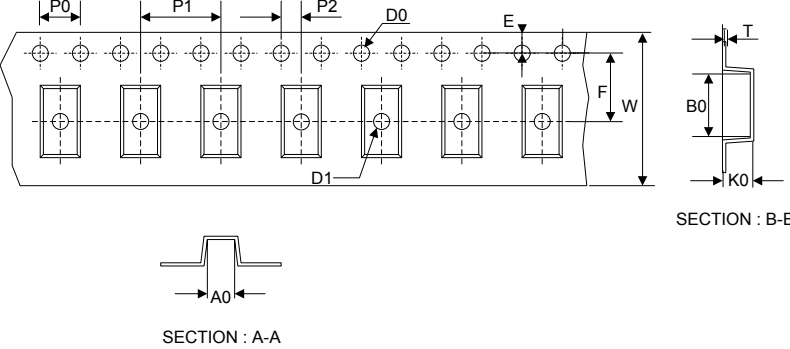
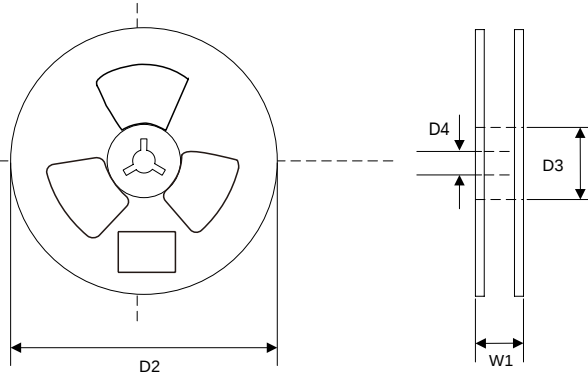


Dimensions in inches and (millimeters)



Dimensions	Value (in mm)
C	1.84
G	1.00
X	3.50
X1	1.40
Y	4.90
Y1	1.50

Tape & reel specification

Tape		Symbol	Dimension (mm)
		P0	4.00±0.20
		P1	8.00±0.20
		P2	2.00±0.20
		D0	1.55±0.20
		D1	1.55±0.20
		E	1.75±0.15
		F	5.50±0.20
		W	12.00±0.20
		A0	4.50±0.20
		B0	6.80±0.20
		K0	1.35±0.20
		T	0.23±0.10
13" Reel			
		D2	330.0±5.0
		D3	73Min.
		D4	13.5±2.5
		W1	16.0±3.0
		Quantity: 5000PCS	